# RENESAS

### NOT RECOMMENDED FOR NEW DESIGNS RECOMMENDED REPLACEMENT PARTS ISL21090, ISL21007, X60003

# DATASHEET

# ISL21009

## High Voltage Input Precision, Low Noise FGA™ Voltage References

#### FN6327 Rev 7.00 September 16, 2009

The ISL21009 FGA<sup>TM</sup> voltage references are extremely low power, high precision, and low noise voltage references fabricated on Intersil's proprietary Floating Gate Analog technology. The ISL21009 features very low noise ( $4.5\mu V_{P-P}$ for 0.1Hz to 10Hz), low operating current ( $180\mu A$ , Max), and 3ppm/°C of temperature drift. In addition, the ISL21009 family features guaranteed initial accuracy as low as ±0.5mV.

This combination of high initial accuracy, low power and low output noise performance of the ISL21009 enables versatile high performance control and data acquisition applications with low power consumption.

# Available Options

PART NUMBER	V <sub>OUT</sub> OPTION (V)	INITIAL ACCURACY (mV)	TEMPCO. (ppm/°C)
ISL21009BFB812Z	1.250	±0.5	3
ISL21009CFB812Z	1.250	±1.0	5
ISL21009DFB812Z	1.250	±2.0	10
ISL21009BFB825Z	2.500	±0.5	3
ISL21009CFB825Z	2.500	±1.0	5
ISL21009DFB825Z	2.500	±2.0	10
ISL21009BFB841Z	4.096	±0.5	3
ISL21009CFB841Z	4.096	±1.0	5
ISL21009DFB841Z	4.096	±2.0	10
ISL21009BFB850Z	5.000	±0.5	3
ISL21009CFB850Z	5.000	±1.0	5
ISL21009DFB850Z	5.000	±2.0	10

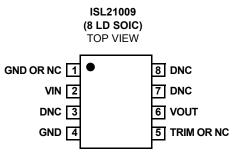
### Features

• Output Voltages
• Initial Accuracy ±0.5mV, ±1.0mV, ±2.0mV
Input Voltage Range
+ Output Voltage Noise
• Supply Current
<ul> <li>Temperature Coefficient3ppm/°C, 5ppm/°C, 10ppm/°C</li> </ul>
Output Current CapabilityUp to ±7.0mA
Operating Temperature Range40°C to +125°C
Package 8 Ld SOIC
Pb-Free (RoHS Compliant)

# Applications

- High Resolution A/Ds and D/As
- Digital Meters
- Bar Code Scanners
- Basestations
- Battery Management/Monitoring
- Industrial/Instrumentation Equipment

### Pinout





# **Pin Descriptions**

PIN NUMBER	PIN NAME	DESCRIPTION
1	GND or NC	Can be either Ground or No Connect
2	VIN	Power Supply Input Connection
4	GND	Ground Connection
5	TRIM or NC	Allows user trim typically ±2.5%. Leave Unconnected when unused.
6	VOUT	Voltage Reference Output Connection
3, 7, 8	DNC	Do Not Connect; Internal Connection – Must Be Left Floating

# **Ordering Information**

PART NUMBER (Notes 1, 2)	PART MARKING	V <sub>OUT</sub> OPTION (V)	GRADE	TEMP. RANGE (°C)	PACKAGE (Pb-Free)	PKG. DWG. #
ISL21009BFB812Z	21009BF Z12	1.250	±0.5mV, 3ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009CFB812Z	21009CF Z12	1.250	±1.0mV, 5ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009DFB812Z	21009DF Z12	1.250	±2.0mV, 10ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009BFB825Z	21009BF Z25	2.500	±0.5mV, 3ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009CFB825Z	21009CF Z25	2.500	±1.0mV, 5ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009DFB825Z	21009DF Z25	2.500	±2.0mV, 10ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009BFB841Z	21009BF Z41	4.096	±0.5mV, 3ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009CFB841Z	21009CF Z41	4.096	±1.0mV, 5ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009DFB841Z	21009DF Z41	4.096	±2.0mV, 10ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009BFB850Z	21009BF Z50	5.000	±0.5mV, 3ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009CFB850Z	21009CF Z50	5.000	±1.0mV, 5ppm/°C	-40 to +125	8 Ld SOIC	M8.15
ISL21009DFB850Z	21009DF Z50	5.000	±2.0mV, 10ppm/°C	-40 to +125	8 Ld SOIC	M8.15

NOTES:

 These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

2. Add "-TK" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

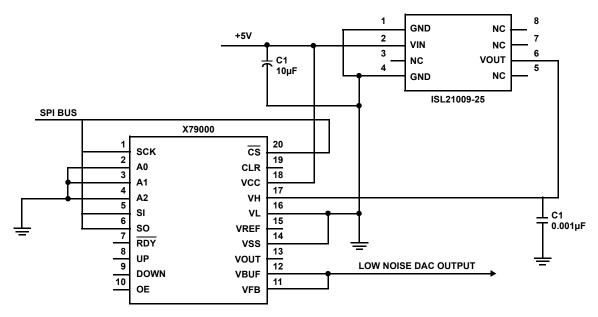


FIGURE 1. TYPICAL APPLICATION PRECISION 12-BIT SUB-RANGING DAC



### Absolute Voltage Ratings

Max Voltage V <sub>IN</sub> to GND	0.5V to +18V
Max Voltage V <sub>OUT</sub> to GND (10s)	0.5V to V <sub>OUT</sub> +1V
Voltage on "DNC" pins No conn	ections permitted to these pins.
ESD Ratings	
Human Body Model	6kV
Charged Device Model	

### **Thermal Information**

Thermal Resistance (Typical, Note 3)	θ <sub>JA</sub> (°C/W)
8 Ld SOIC	. 115
Storage Temperature Range6	5°C to +150°C
Pb-free Reflow Profile (Note 4)	see link below
http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

### **Recommended Operating Conditions**

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

#### NOTES:

- 3.  $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- Post-reflow drift for the ISL21009 devices will range from 100µV to 1.0mV based on experimental results with devices tested in sockets and also on FR4 multi-layer PC boards. The design engineer must take this into account when considering the reference voltage after assembly.

### Common Electrical Specifications (ISL21009-12, -25, -41, -50) T<sub>A</sub> = -40°C to +125°C, I<sub>OUT</sub> = 0, unless otherwise specified.

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PARAMETER	DESCRIPTION	CONDITIONS	MIN	ТҮР	MAX	UNIT
V <sub>OA</sub>	V <sub>OUT</sub> Accuracy @ T <sub>A</sub> = +25°C	ISL21009B	-0.5		+0.5	mV
		ISL21009C	-1.0		+1.0	mV
		ISL21009D	-2.0		+2.0	mV
TC V <sub>OUT</sub>	Output Voltage Temperature	ISL21009B			3	ppm/°C
	Coefficient (Note 5)	ISL21009C			5	ppm/°C
		ISL21009D			10	ppm/°C
I <sub>IN</sub>	Supply Current			95	180	μA
$\Delta V_{OUT}$ / $V_{OUT}$	Trim Range		±2.0	±2.5		%
I <sub>SC</sub>	Short Circuit Current	$T_A = +25^{\circ}C$ , $V_{OUT}$ tied to GND		10		mA
t <sub>R</sub>	Turn-on Settling Time	V <sub>OUT</sub> = ±0.1%		100		μs
	Ripple Rejection	f = 10kHz		60		dB
e <sub>N</sub>	Output Voltage Noise	$0.1Hz \leq f \leq 10Hz$		4.5		μV <sub>P-P</sub>
V <sub>N</sub>	Broadband Voltage Noise	$10Hz \le f \le 1kHz$		2.2		μV <sub>RMS</sub>

### **Electrical Specifications (ISL21009-12, V**<sub>OUT</sub> = 1.250V) $V_{IN}$ = 5.0V, $T_A$ = -40°C to +125°C, $I_{OUT}$ = 0, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>OUT</sub>	Output Voltage			1.250		V
V <sub>IN</sub>	Input Voltage Range		3.5		16.5	V
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	3.5V <u>≤</u> V <sub>IN</sub> <u>≤</u> 5.5V		50	150	μV/V
		5.5V <u>≤</u> V <sub>IN</sub> <u>≤</u> 16.5V		10	50	μV/V
$\Delta V_{OUT} / \Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 7mA$		10	50	μV/mA
		Sinking: -7mA $\leq$ I <sub>OUT</sub> $\leq$ 0mA		20	100	μV/mA
$\Delta V_{OUT} / \Delta T_A$	Thermal Hysteresis (Note 6)	ΔT <sub>A</sub> = +165°C		50		ppm
$\Delta V_{OUT} / \Delta t$	Long Term Stability (Note 7)	T <sub>A</sub> = +25°C		50		ppm

PARAMETER	DESCRIPTION	CONDITIONS	MIN	ТҮР	MAX	UNIT
V <sub>OUT</sub>	Output Voltage			2.500		V
V <sub>IN</sub>	Input Voltage Range		3.5		16.5	V
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	$3.5V \le V_{IN} \le 5.5V$		50	150	μV/V
		5.5V <u>≤</u> V <sub>IN</sub> <u>≤</u> 16.5V		10	50	μV/V
$\Delta V_{OUT} / \Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 7mA$		10	50	μV/mA
		Sinking: -7mA $\leq I_{OUT} \leq 0mA$		20	100	μV/mA
$\Delta V_{OUT} / \Delta T_A$	Thermal Hysteresis (Note 6)	ΔT <sub>A</sub> = +165°C		50		ppm
$\Delta V_{OUT} / \Delta t$	Long Term Stability (Note 7)	T <sub>A</sub> = +25°C		50		ppm

### **Electrical Specifications (ISL21009-25, V<sub>OUT</sub> = 2.50V)** $V_{IN} = 5.0V$ , $T_A = -40^{\circ}C$ to $+125^{\circ}C$ , $I_{OUT} = 0$ , unless otherwise specified.

### Electrical Specifications (ISL21009-41, V<sub>OUT</sub> = 4.096V)

 $V_{IN}$  = 5.0V,  $T_A$  = -40°C to +125°C,  $I_{OUT}$  = 0 unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>OUT</sub>	Output Voltage			4.096		V
V <sub>IN</sub>	Input Voltage Range		4.5		16.5	V
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	4.5V <u>≤</u> V <sub>IN</sub> <u>≤</u> 16.5V		50	200	μV/V
$\Delta V_{OUT} / \Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 5mA$		20	100	μV/mA
		Sinking: $-5mA \le I_{OUT} \le 0mA$		20	150	μV/mA
$\Delta V_{OUT} / \Delta T_A$	Thermal Hysteresis (Note 6)	∆T <sub>A</sub> = +165°C		50		ppm
$\Delta V_{OUT} / \Delta t$	Long Term Stability (Note 7)	T <sub>A</sub> = +25°C		50		ppm

Electrical Specifications (ISL21009-50,  $V_{OUT} = 5.0V$ )  $V_{IN} = 10.0V$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $I_{OUT} = 0$  unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>OUT</sub>	Output Voltage			5.000		V
V <sub>IN</sub>	Input Voltage Range		5.5		16.5	V
$\Delta V_{OUT} / \Delta V_{IN}$	Line Regulation	5.5V <u>≤</u> V <sub>IN</sub> <u>≤</u> 16.5V		20	90	μV/V
$\Delta V_{OUT} / \Delta I_{OUT}$	Load Regulation	Sourcing: $0mA \le I_{OUT} \le 7mA$		10	100	μV/mA
		Sinking: -7mA $\leq I_{OUT} \leq 0$ mA		20	150	μV/mA
$\Delta V_{OUT} / \Delta T_A$	Thermal Hysteresis (Note 6)	ΔT <sub>A</sub> = +165°C		50		ppm
$\Delta V_{OUT} / \Delta t$	Long Term Stability (Note 7)	T <sub>A</sub> = +25°C		50		ppm

NOTES:

 Over the specified temperature range. Temperature coefficient is measured by the box method whereby the change in V<sub>OUT</sub> is divided by the temperature range; in this case, -40°C to +125°C = +165°C.

6. Thermal Hysteresis is the change of V<sub>OUT</sub> measured @ T<sub>A</sub> = +25°C after temperature cycling over a specified range, ∆T<sub>A</sub>. V<sub>OUT</sub> is read initially at T<sub>A</sub> = +25°C for the device under test. The device is temperature cycled and a second V<sub>OUT</sub> measurement is taken at +25°C. The difference between the initial V<sub>OUT</sub> reading and the second V<sub>OUT</sub> reading is then expressed in ppm. For ∆ T<sub>A</sub> = +165°C, the device under test is cycled from +25°C to +125°C to -40°C to +25°C.

7. Long term drift is logarithmic in nature and diminishes over time. Drift after the first 1000 hours will be approximately 10ppm//(1kHrs).

# Typical Performance Curves (ISL21009-12) (R<sub>EXT</sub> = 100kΩ)

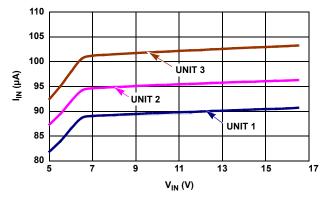


FIGURE 2. I<sub>IN</sub> vs V<sub>IN</sub>, 3 UNITS

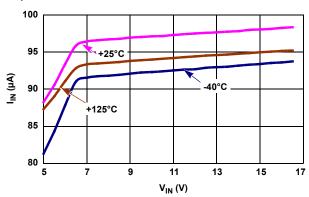


FIGURE 3.  $I_{IN}$  vs  $V_{IN}$ , 3 TEMPERATURES

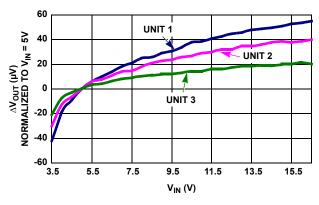


FIGURE 4. LINE REGULATION, 3 UNITS

+25°C

2 3

0

**OUTPUT CURRENT (mA)** 

FIGURE 6. LOAD REGULATION

1

-40°C

4 5 6

SOURCING

7

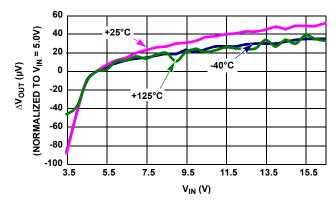
1

+125°C

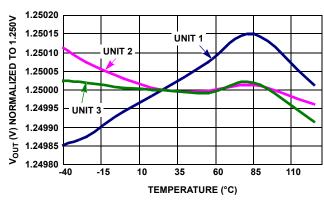
-3

-4

-2 -1









0.08

0.06

0.04

0.02

0.00

-0.02

-0.04

-0.06

-0.08

-0.10 -0.12

-7 -6 -5

SINKING

∆V<sub>OUT</sub> (mV)

# Typical Performance Curves (ISL21009-12) (R<sub>EXT</sub> = 100kΩ) (Continued)

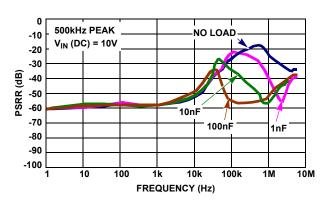


FIGURE 8. PSRR AT DIFFERENT CAPACITIVE LOADS

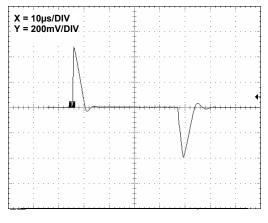
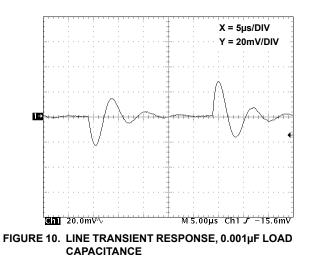


FIGURE 9. LINE TRANSIENT RESPONSE, NO CAPACITIVE LOAD



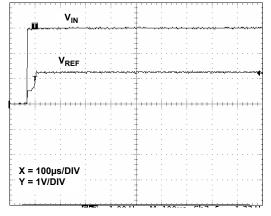
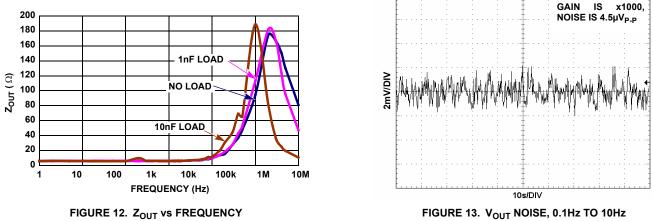


FIGURE 11. TURN-ON TIME







# **Typical Performance Curves (ISL21009-12)** (*R*<sub>EXT</sub> = 100k<sup>Ω</sup>) (Continued)

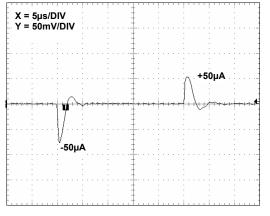


FIGURE 14. LOAD TRANSIENT RESPONSE

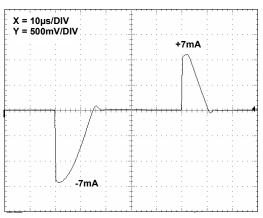
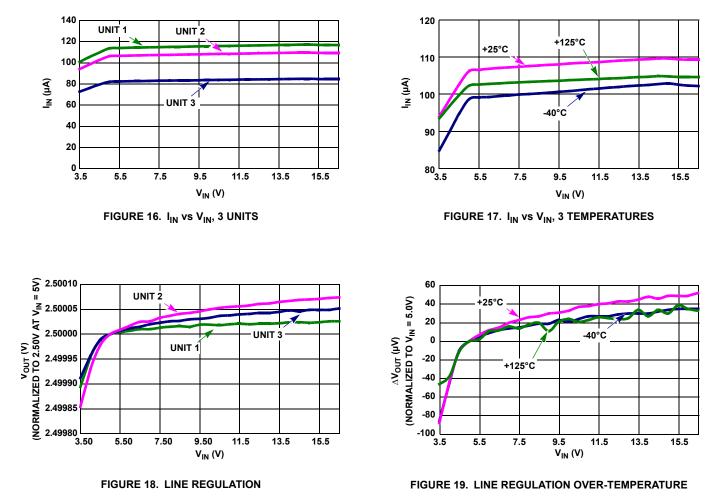
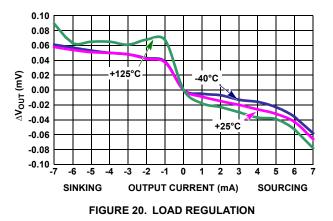


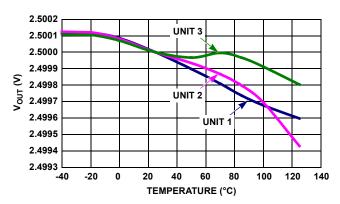
FIGURE 15. LOAD TRANSIENT RESPONSE

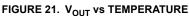




# Typical Performance Curves (ISL21009-25) (R<sub>EXT</sub> = 100kΩ) (Continued)







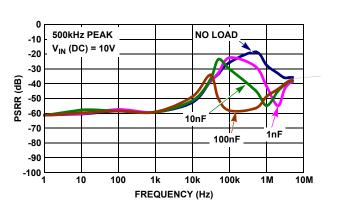
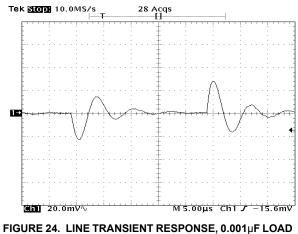


FIGURE 22. PSRR AT DIFFERENT CAPACITIVE LOADS



JRE 24. LINE TRANSIENT RESPONSE, 0.001µ CAPACITANCE

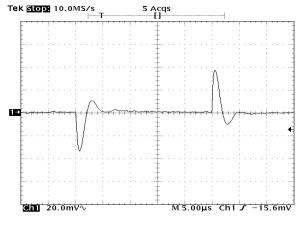
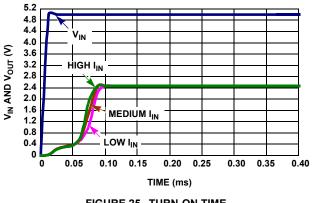
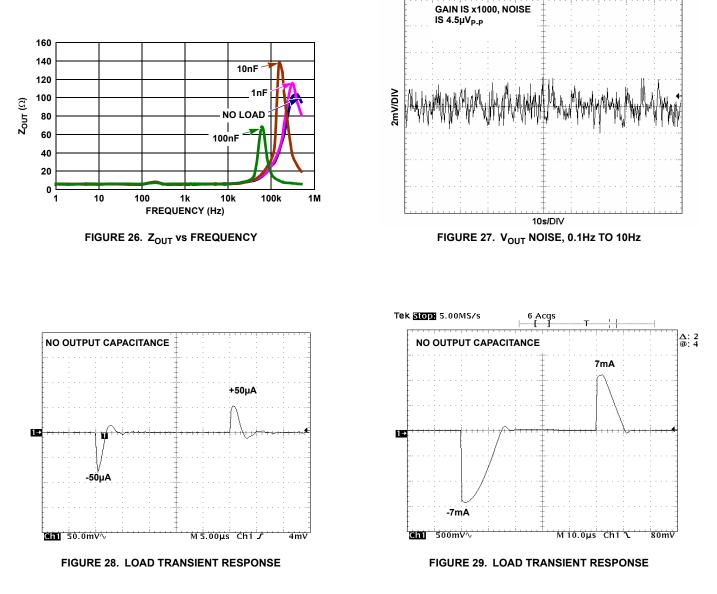


FIGURE 23. LINE TRANSIENT RESPONSE, NO CAPACITIVE LOAD

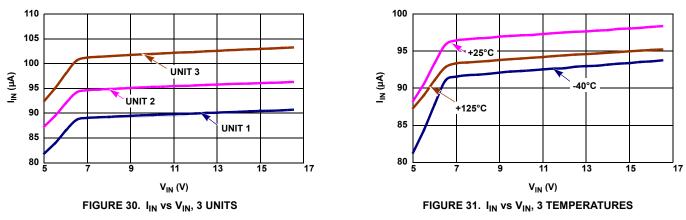




# **Typical Performance Curves (ISL21009-25)** (*R*<sub>EXT</sub> = 100kΩ) (Continued)







# Typical Performance Curves (ISL21009-41) (R<sub>EXT</sub> = 100kΩ) (Continued)

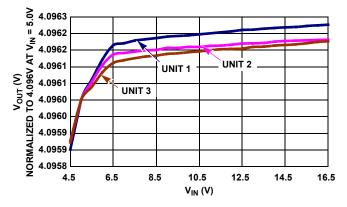


FIGURE 32. LINE REGULATION, 3 UNITS

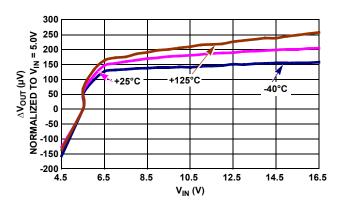
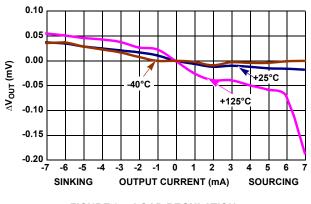
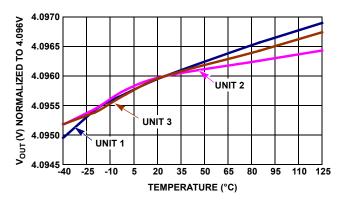
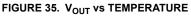


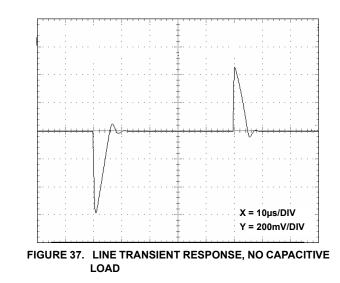
FIGURE 33. LINE REGULATION OVER-TEMPERATURE











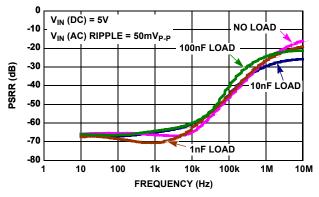


FIGURE 36. PSRR AT DIFFERENT CAPACITIVE LOADS



# **Typical Performance Curves (ISL21009-41)** (R<sub>EXT</sub> = 100kΩ) (Continued)

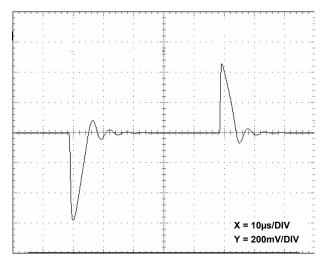


FIGURE 38. LINE TRANSIENT RESPONSE, 0.001µF LOAD CAPACITANCE

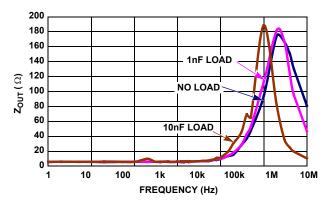


FIGURE 40. Z<sub>OUT</sub> vs FREQUENCY

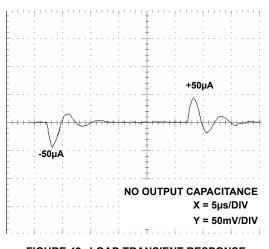


FIGURE 42. LOAD TRANSIENT RESPONSE

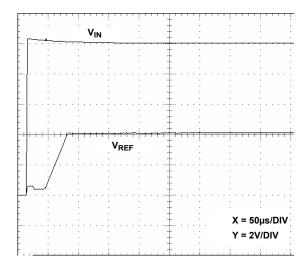


FIGURE 39. TURN-ON TIME

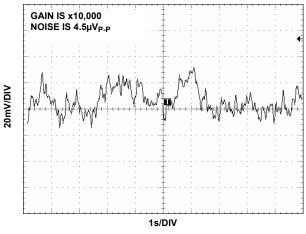


FIGURE 41. V<sub>OUT</sub> NOISE, 0.1Hz TO 10Hz

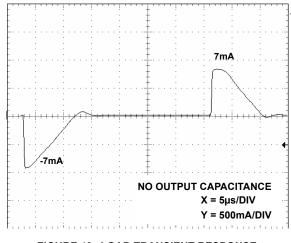
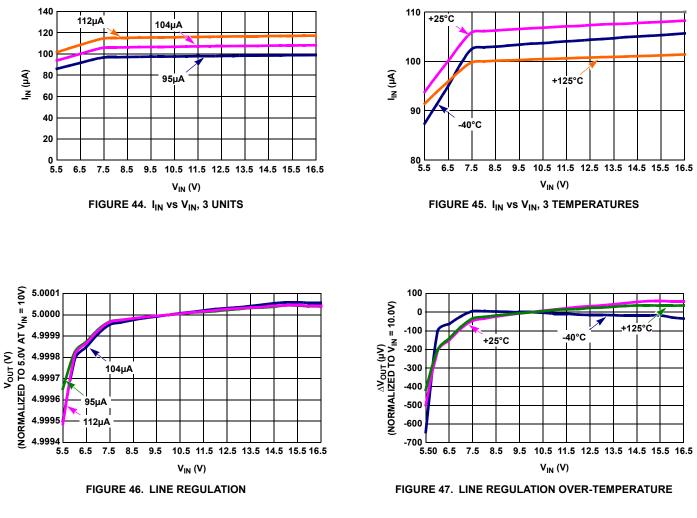
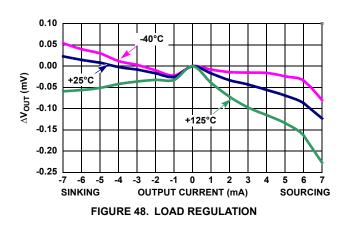


FIGURE 43. LOAD TRANSIENT RESPONSE



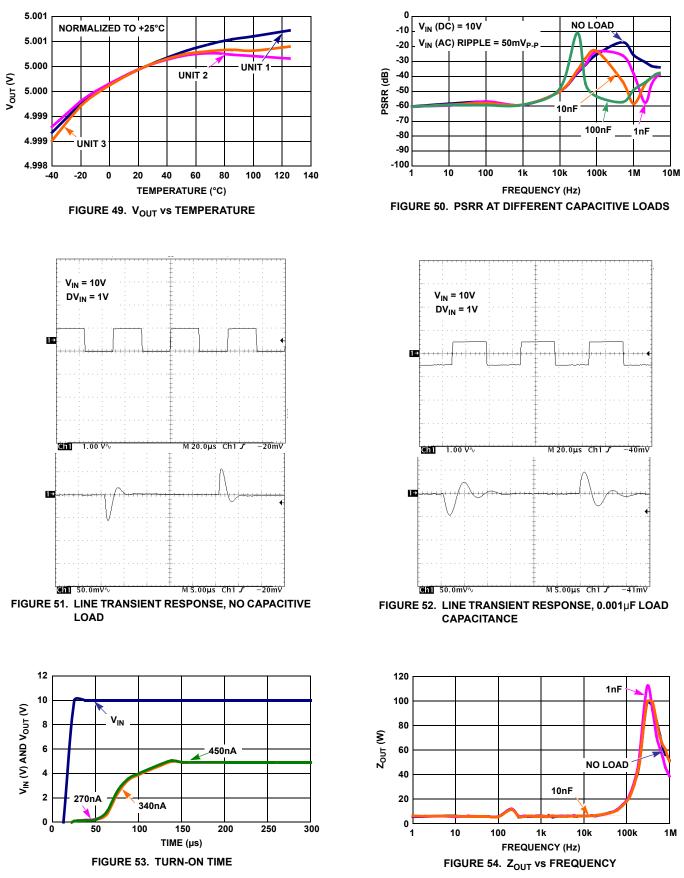
# Typical Performance Curves (ISL21009-50) (R<sub>EXT</sub> = 100kΩ)



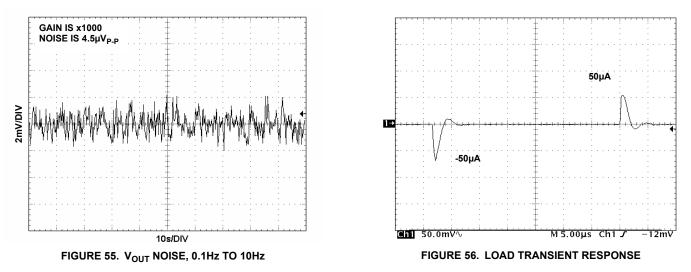


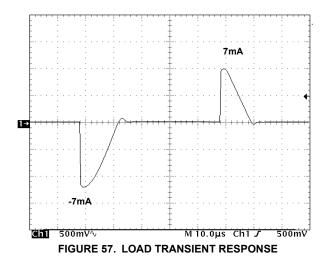


# Typical Performance Curves (ISL21009-50) (R<sub>EXT</sub> = 100kΩ) (Continued)



# **Typical Performance Curves (ISL21009-50)** (*R*<sub>EXT</sub> = 100kΩ) (Continued)





### Applications Information

### FGA Technology

The ISL21009 voltage reference uses floating gate technology to create references with very low drift and supply current. Essentially the charge stored on a floating gate cell is set precisely in manufacturing. The reference voltage output itself is a buffered version of the floating gate voltage. The resulting reference device has excellent characteristics, which are unique in the industry: very low temperature drift, high initial accuracy, and almost zero supply current. Also, the reference voltage itself is not limited by voltage bandgaps or zener settings, so a wide range of reference voltages can be programmed (standard voltage settings are provided, but customer-specific voltages are available). The process used for these reference devices is a floating gate CMOS process and the amplifier circuitry uses CMOS transistors for amplifier and output transistor circuitry. While providing excellent accuracy, there are limitations in output noise level and load regulation due to the MOS device characteristics. These limitations are addressed with circuit techniques discussed in other sections.

### **Micropower Operation**

The ISL21009 consumes extremely low supply current due to the proprietary FGA technology. Low noise performance is achieved using optimized biasing techniques. Supply current is typically 95 $\mu$ A and noise is  $4.5\mu$ V<sub>P-P</sub> benefitting precision, low noise portable applications such as handheld meters and instruments.



Data Converters in particular can utilize the ISL21009 as an external voltage reference. Low power DAC and ADC circuits will realize maximum resolution with lowest noise.

### **Board Mounting Considerations**

For applications requiring the highest accuracy, board mounting location should be reviewed. The device uses a plastic SOIC package, which will subject the die to mild stresses when the Printed Circuit (PC) board is heated and cooled, slightly changing the shape. Placing the device in areas subject to slight twisting can cause degradation of the accuracy of the reference voltage due to these die stresses. It is normally best to place the device near the edge of a board, or the shortest side, as the axis of bending is most limited at that location. Mounting the device in a cutout also minimizes flex. Obviously mounting the device on flexprint or extremely thin PC material will likewise cause loss of reference accuracy.

### **Board Assembly Considerations**

FGA references provide high accuracy and low temperature drift but some PC board assembly precautions are necessary. Normal Output voltage shifts of 100µV to 1mV can be expected with Pb-free reflow profiles or wave solder on multi-layer FR4 PC boards. Precautions should be taken to avoid excessive heat or extended exposure to high reflow or wave solder temperatures, this may reduce device initial accuracy.

Post-assembly x-ray inspection may also lead to permanent changes in device output voltage and should be minimized or avoided. If x-ray inspection is required, it is advisable to monitor the reference output voltage to verify excessive shift has not occurred. If large amounts of shift are observed, it is best to add an X-ray shield consisting of thin zinc ( $300\mu m$ ) sheeting to allow clear imaging, yet block x-ray energy that affects the FGA reference.

### Special Applications Considerations

In addition to post-assembly examination, there are also other X-ray sources that may affect the FGA reference long term accuracy. Airport screening machines contain X-rays and will have a cumulative effect on the voltage reference output accuracy. Carry-on luggage screening uses low level X-rays and is not a major source of output voltage shift, although if a product is expected to pass through that type of screening over 100 times it may need to consider shielding with copper or aluminum. Checked luggage X-rays are higher intensity and can cause output voltage shift in much fewer passes, so devices expected to go through those machines should definitely consider shielding. Note that just two layers of 1/2 ounce copper planes will reduce the received dose by over 90%. The leadframe for the device which is on the bottom also provides similar shielding.

If a device is expected to pass through luggage X-ray machines numerous times, it is advised to mount a 2-layer (minimum) PC board on the top, and along with a ground plane underneath will effectively shield it from from 50 to 100 passes through the machine. Since these machines vary in X-ray dose delivered, it is difficult to produce an accurate maximum pass recommendation.

### Noise Performance and Reduction

The output noise voltage in a 0.1Hz to 10Hz bandwidth is typically  $4.5\mu V_{P-P}$ . The noise measurement is made with a bandpass filter made of a 1-pole high-pass filter with a corner frequency at 0.1Hz and a 2-pole low-pass filter with a corner frequency (3dB) at 8.2Hz to create a filter with a 9.9Hz bandwidth. Noise in the 10Hz to 1kHz bandwidth is approximately  $2.2\mu V_{P-P}$  with no capacitance on the output. This noise measurement is made with a 2 decade bandpass filter made of a 1-pole high-pass filter with a corner frequency at 1/10 of the center frequency and 1-pole low-pass filter with a corner frequency at 10x the center frequency. Load capacitance up to 1000pF can be added but will result in only marginal improvements in output noise and transient response.

The output stage of the ISL21009 does not drive heavily capacitive loads well, so for load capacitances above 0.001µF, the noise reduction network shown in Figure 58 is recommended. This network reduces noise significantly over the full bandwidth. Noise is reduced to less than  $15\mu V_{P-P}$  from 1Hz to 1kHz using this network with a 0.01µF capacitor and a  $2k\Omega$  resistor in series with a 10µF capacitor. Also, transient response is improved. The 0.01µF value can be increased for better load transient response with little sacrifice in output stability.

Higher output capacitor values can be used without the RC network to address transient loads without stability problems, although there will be more overshoot an longer settling times with values up to  $1.0\mu$ F. Output capacitor values greater than  $1.0\mu$ F are not recommended for the ISL21009.

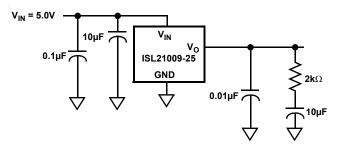


FIGURE 58. HANDLING HIGH LOAD CAPACITANCE

### Turn-On Time

The ISL21009 devices have low supply current and thus, the time to bias up internal circuitry to final values will be longer than with higher power references. Normal turn-on time is typically  $100\mu$ s, as shown in Figure 25. Circuit design must take this into account when looking at power-up delays or sequencing.

### Temperature Coefficient

The limits stated for temperature coefficient (tempco) are governed by the method of measurement. The overwhelming standard for specifying the temperature drift of a reference is to measure the reference voltage at two temperatures, take the total



variation,  $(V_{HIGH} - V_{LOW})$ , and divide by the temperature extremes of measurement  $(T_{HIGH} - T_{LOW})$ . The result is divided by the nominal reference voltage (at T = +25°C) and multiplied by  $10^6$  to yield ppm/°C. This is the "Box" method for specifying temperature coefficient.

### **Output Voltage Adjustment**

The output voltage can be adjusted up or down by 2.5% by placing a potentiometer from  $V_{OUT}$  to GND and connecting the *Typical Application Circuits* 

wiper to the TRIM pin. The TRIM input is high impedance so no series resistance is needed. The resistor in the potentiometer should be a low tempco (<50ppm/°C) and the resulting voltage divider should have very low tempco <5ppm/°C. A digital potentiometer such as the ISL95810 provides a low tempco resistance and excellent resistor and tempco matching for trim applications.

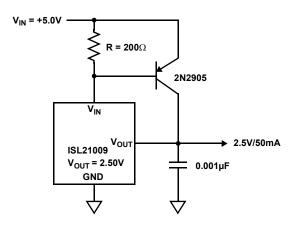


FIGURE 59. PRECISION 2.5V, 50mA REFERENCE

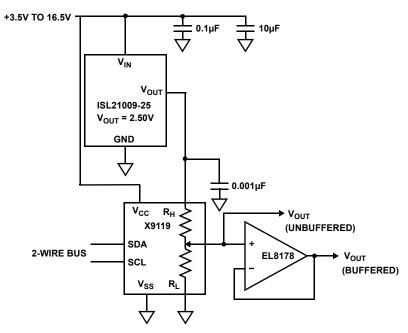
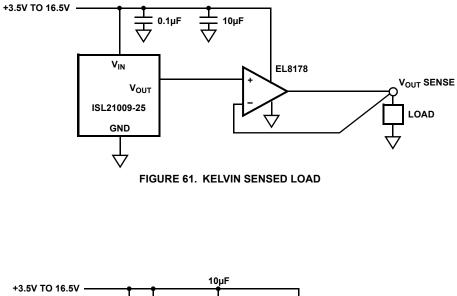
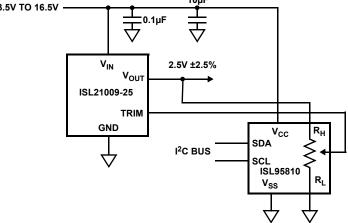


FIGURE 60. 2.5V FULL SCALE LOW-DRIFT, LOW NOISE, 10-BIT ADJUSTABLE VOLTAGE SOURCE

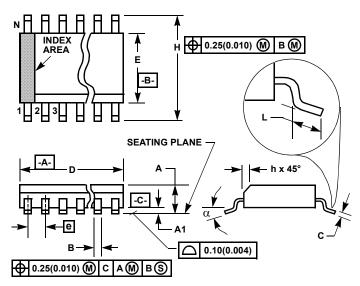
# Typical Application Circuits (Continued)







# Small Outline Plastic Packages (SOIC)



#### NOTES:

- 1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

#### M8.15 (JEDEC MS-012-AA ISSUE C) 8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

	INCH	IES	MILLIN	IETERS	
SYMBOL	MIN	MAX	MIN	MAX	NOTES
А	0.0532	0.0688	1.35	1.75	-
A1	0.0040	0.0098	0.10	0.25	-
В	0.013	0.020	0.33	0.51	9
С	0.0075	0.0098	0.19	0.25	-
D	0.1890	0.1968	4.80	5.00	3
E	0.1497	0.1574	3.80	4.00	4
е	0.050	BSC	1.27 BSC		-
Н	0.2284	0.2440	5.80	6.20	-
h	0.0099	0.0196	0.25	0.50	5
L	0.016	0.050	0.40	1.27	6
Ν	8			8	7
а	0°	8°	0°	8°	-

Rev. 1 6/05

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